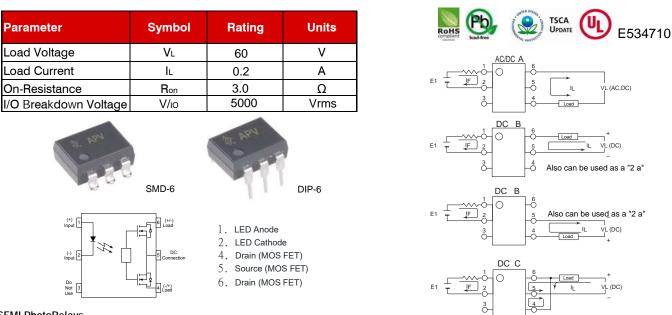
PSEM

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1 Form A APV221E_EH SMD-6/DIP-6 Load Voltage:60V Load Current:200mA



APSEMI PhotoRelays

APSEMI Photorelays are the most reliable, technically advanced logic-to-power interface devices. Their basic function is to take a low current signal from a microprocessor to control the switching of both AC and DC loads, while providing an isolation barrier between logic and power. While this function is common to all relays, Photorelays provide distinct advantages over their mechanical counterparts including:

- Long life (No limit on mechanical and electrical
- lifetime)Bounce-free switching
- Higher speed and high frequency switching
- Higher sensitivity (less power consumption)

- No have voltaic arc, bounce, and noise More
- resistant to vibration and impact AC or DC load
- switching
- Small package size

Immunity to EMI or RFI

Applications

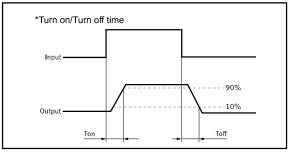
These advantages make APSEI Photorelays the ideal choice for:

- Telecom/Datacom switching •
- Multiplexers •
- Meter reading systems
- Data acquisition
- Medical equipment
- Battery monitoring • •
- I/O Sub-Systems

- Robotics
- Aerospace
- Home/Safety security systems
- Process Control
- **Energy Management**
- Reed Relay EMR Replacement
- Programmable Controllers

TPYES

Category	Output Rating		Poolkaga	Part No.	Packing Quantity	
	Load Voltage	Load Current	Package	Fall NO.	Packing Quantity	
AC/DC	60V	0.2A	DIP-6	APV221E	50pcs /tube	
	60 V	0.2A	SMD-6	APV221EH	1000pcs /reel	



Absolute Maximum Ratings (Ta = 25°C)

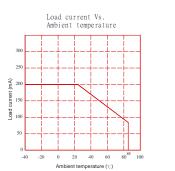
	Item	Symbol	Value	Units	Note
	Continuous LED Current	F	50	mA	
Input	Peak LED Current	FP	1000	mA	f=100Hz, duty=1%
	LED Reverse Voltage	VR	5	V	
	Input Power Dissipation	Pin	75	mW	
	Load Voltage	VL	60	V(AC peak or DC)	
	Load Current	I.	0.2	А	
Output	Peak Load Current	Peak	0.6	А	100ms(1 pulse)
	Output Power Dissipation	Pout	450	mW	
Total Powe	Total Power Dissipation		500	mW	
I/O Breakdown Voltage		Vi/o	5000	Vrms	RH=60%, 1min
Operating Temperature		Topr	-40 to 85	°C	
Storage Temperature		T _{stg}	-40 to 100	C	
Pin Soldering Temperature		Tsol	260	°C	10 sec max.

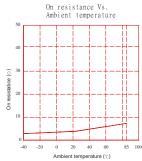
Electrical Characteristics (Ta = 25°C)

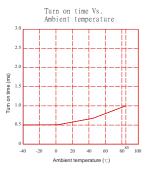
Item		Symbol	MIN.	TYP.	MAX.	Units	Conditions
	LED Forward Voltage	VF		1.2	1.4	V	l⊧=10mA
	Operation LED Current	Fon		0.5	2.0	mA	
Input	Recovery LED Current	Foff		0.35	0.5	mA	
	Recovery LED Voltage	VFoff	0.7			V	
							l⊧=5mA,I∟=100mA,
	On-Resistance	Ron		3.0	6.0	Ω	Time to flow is within 1 sec.
Output	Off-State Leakage	Leak	0.01	0.03	0.10	uA	V₋=Rating
	Current	Leak	0.01	0.05	0.10	uA	
	Output Capacitance	Cout		12		pF	V∟=0, f=1MHz
Transmis	Turn-On Time	Ton		0.05	0.80	ms	l⊧=5mA, l∟=100mA,
sion	Turn-Off Time	Toff		0.05	0.15	ms	
Coupled	I/O Isolation Resistance	Ri⁄o	10 ¹⁰			Ω	DC500V
	I/O Capacitance	Ci/o		0.8	1.5	pF	f=1MHz

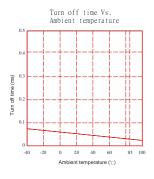
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): IF ≥5mA and ≤30mA

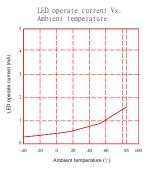
Engineering Data

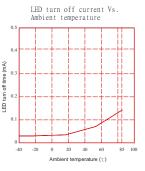










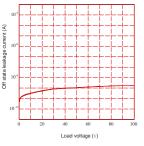


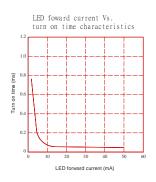
LED forward voltage Vs. Ambient temperature

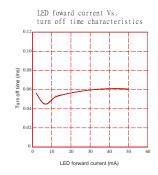


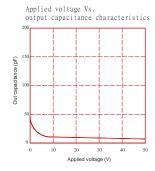
Current A	100 80 60 40 20	+ + + +
	20 40 	4 5 ge, V

Off state leakage current Vs. Load voltage characteristics





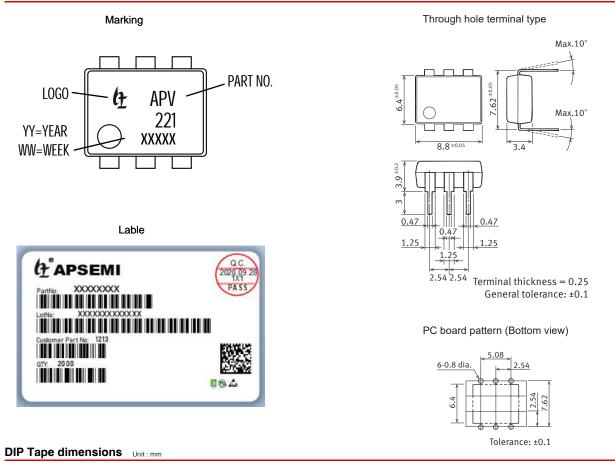




Dimensions and DIP-6 Package Unit: mm

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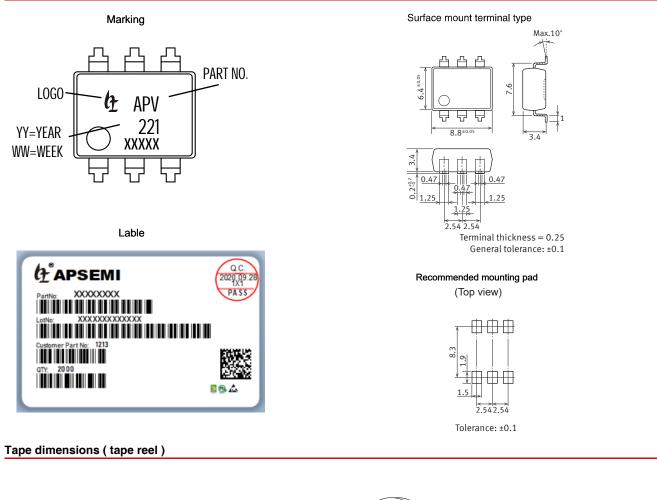
Devices are packaged in a tube so that pin No. 1 is on the stopper B side. Observe correct orientation when mounting them on PC boards.



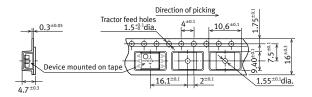
Dimensions and SMD-6 Package Unit: mm

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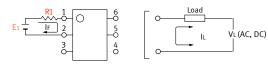


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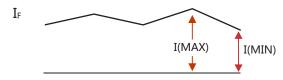
Using Methods

Examples of resistance value to control LED forward current (IF=5mA)



E1	R1 (Approx)
3.3V	300 Ω
5.0V	600 Ω
12V	1.9KΩ
24V	4.1K Ω

LED forward current must be more than 5mA , at I(MIN) ,and less than 30mA , at I(MAX).



Recommended Operating Conditions

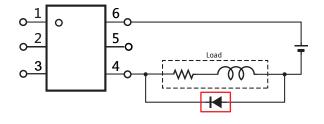
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

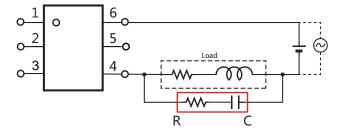
Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	١ _F	5.0	7.0	30	mA

Protection Circuit

Clamp diode is connected in parallel with the load. Absorb capacity with external diode.

CR Snubber is connected in parallel with the load. Absorb capacity with buffer capacity.





When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective. Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.

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